



US00D486802S

(12) **United States Design Patent**  
**Harnden et al.**

(10) **Patent No.:** **US D486,802 S**

(45) **Date of Patent:** **\*\* \*Feb. 17, 2004**

(54) **PORTION OF A MATRIX FOR SURFACE MOUNT PACKAGE LEADFRAME**

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(\* ) Notice: This patent is subject to a terminal disclaimer.

(\*\*) Term: **14 Years**

(21) Appl. No.: **29/172,801**

(22) Filed: **Dec. 17, 2002**

(51) **LOC (7) Cl.** ..... **13-03**

(52) **U.S. Cl.** ..... **D13/182**

(58) **Field of Search** ..... D13/182; 29/622,  
29/827; 174/52.2, 52.4; 206/713, 714, 715,  
716, 727, 728; 257/667, 668; 333/185;  
428/573

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(57) **CLAIM**

The ornamental design for a portion of a matrix for surface mount package leadframe, as shown and described.

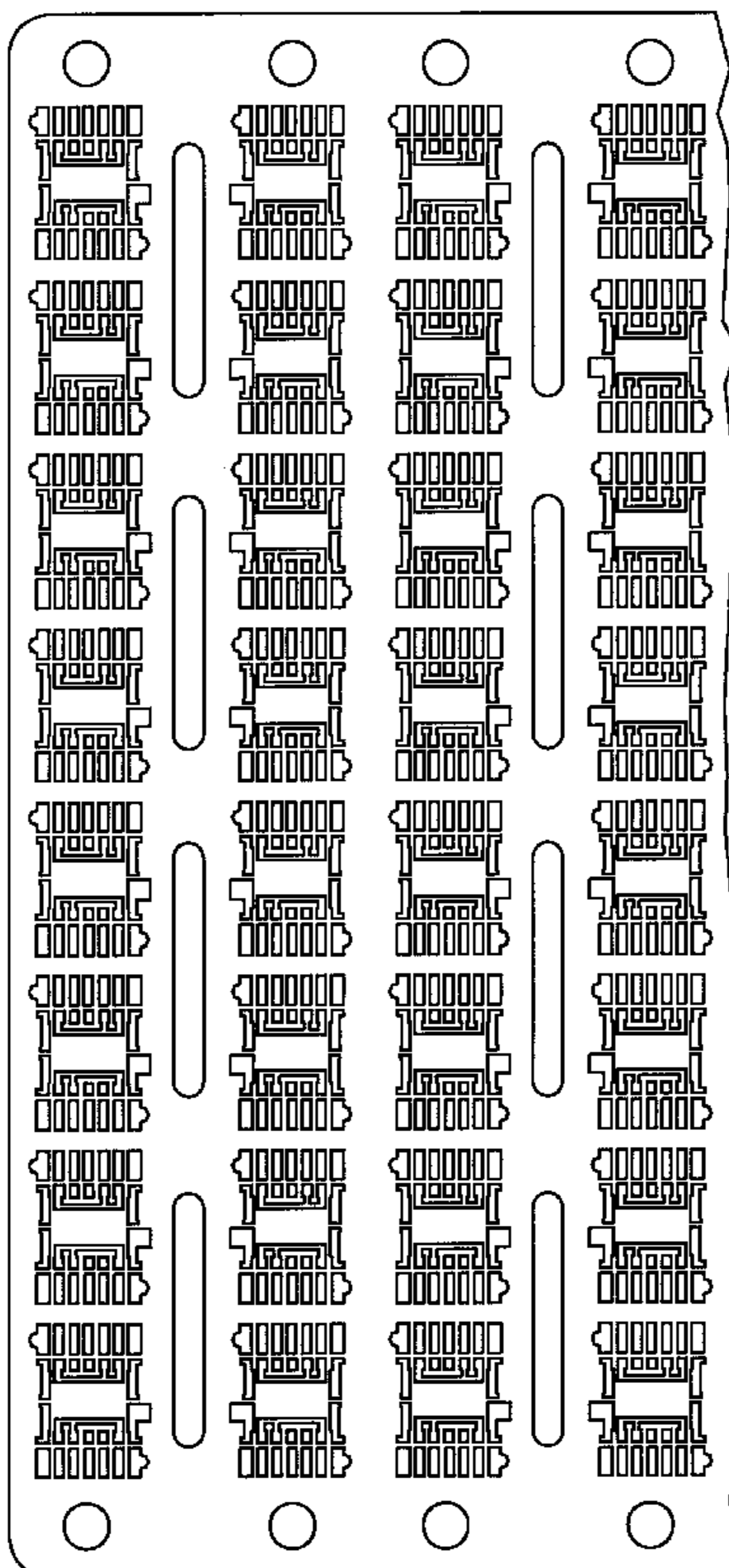
**DESCRIPTION**

FIG. 1 is a top plan view of a portion of a matrix incorporating a plurality of surface mount package leadframes showing my new design;

FIG. 2 is a top plan view of an enlarged fragment of the portion of a matrix for surface mount package leadframe; and,

FIG. 3 is a perspective view of a matrix incorporating a plurality of surface mount package leadframes showing my new design.

**1 Claim, 3 Drawing Sheets**



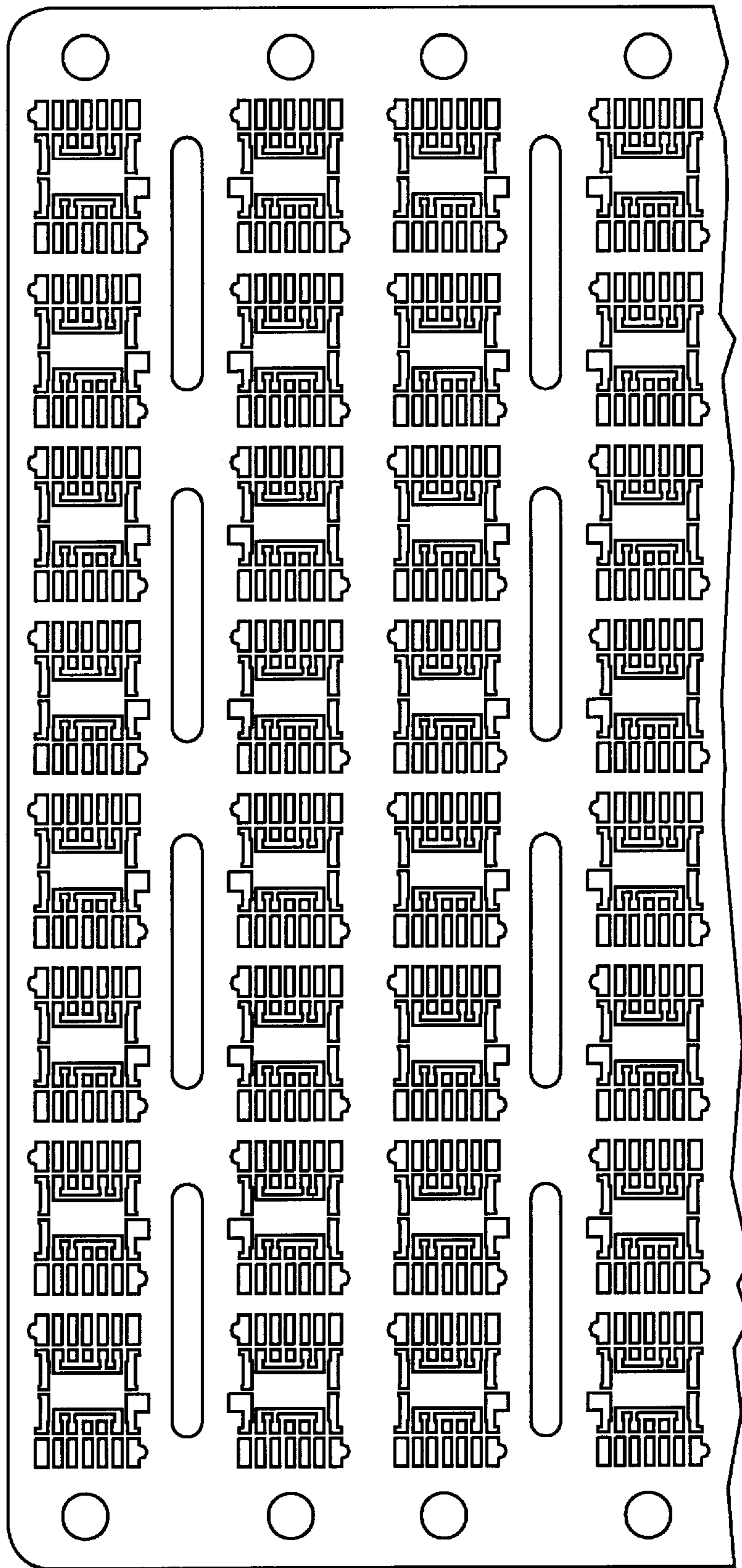


FIG. 1

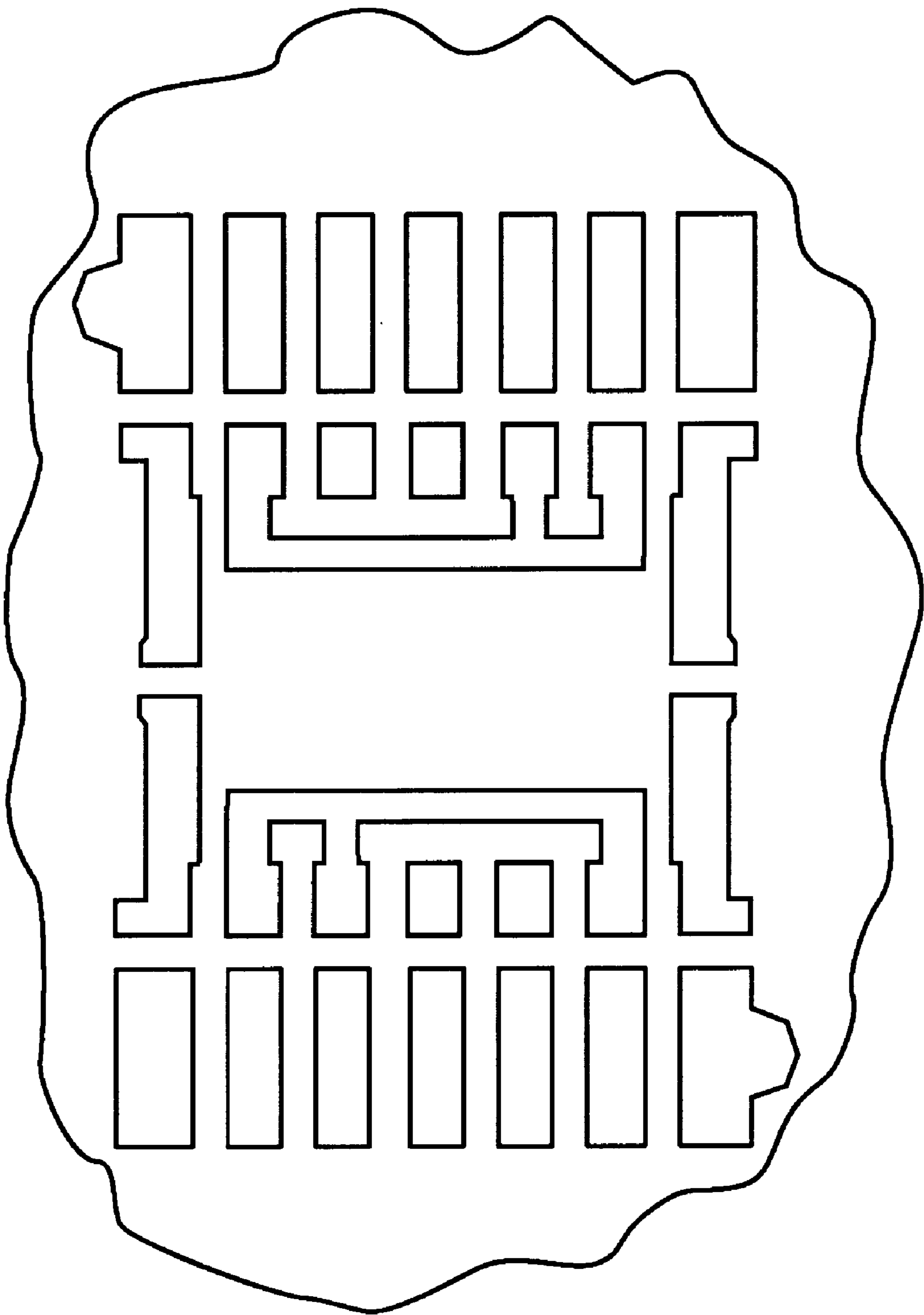


FIG. 2

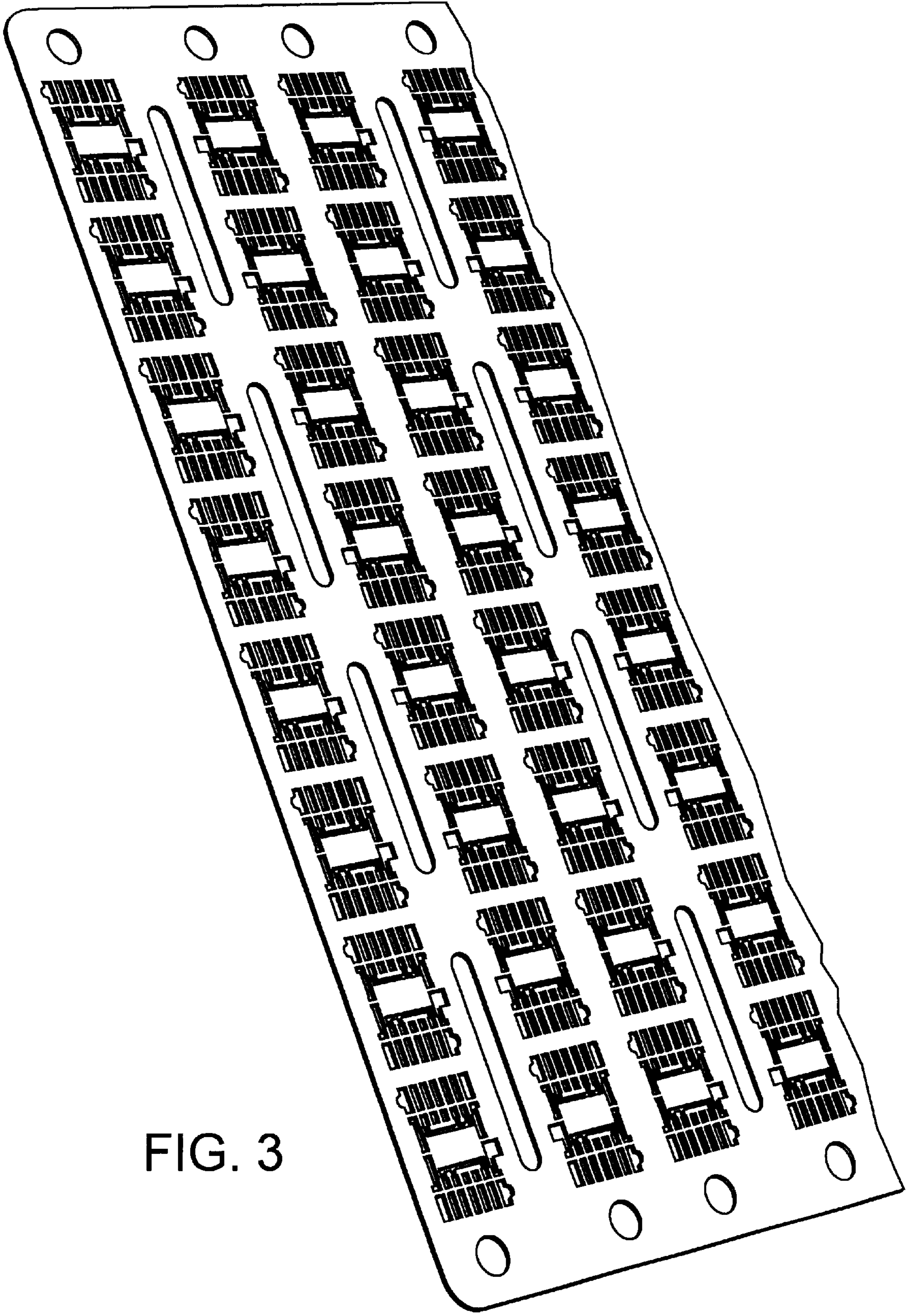


FIG. 3